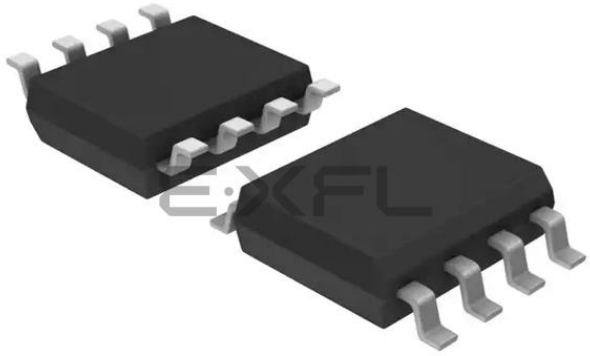

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What is "Embedded - Microcontrollers"?

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	6
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0423sb005eg

On-Chip Debugger

F0823 Series products feature an integrated On-Chip Debugger. The OCD provides a rich-set of debugging capabilities, such as reading and writing registers, programming Flash memory, setting breakpoints and executing code. A single-pin interface provides communication to the OCD.

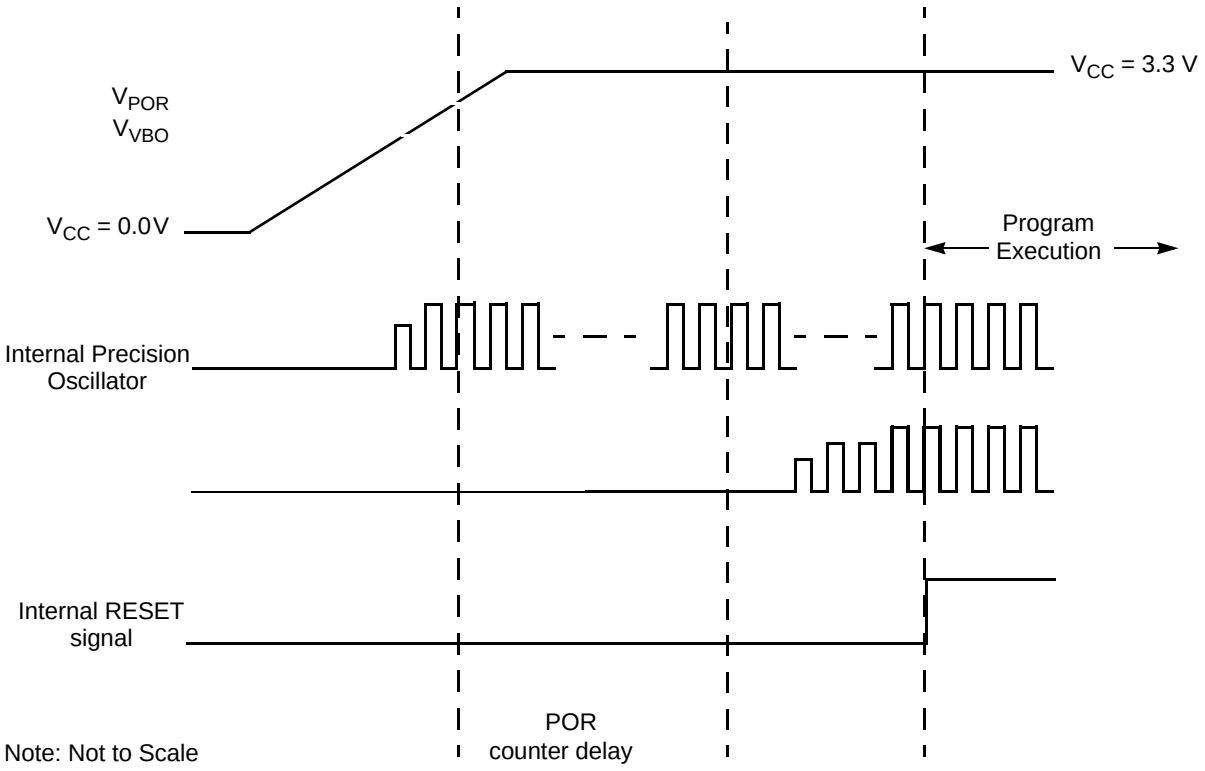

Figure 5. Power-On Reset Operation

Voltage Brown-Out Reset

The devices in the Z8 Encore! XP F0823 Series provide low VBO protection. The VBO circuit senses when the supply voltage drops to an unsafe level (below the VBO threshold voltage) and forces the device into the Reset state. While the supply voltage remains below the POR voltage threshold (V_{POR}), the VBO block holds the device in the Reset.

After the supply voltage again exceeds the Power-On Reset voltage threshold, the device progresses through a full System Reset sequence, as described in the Power-On Reset section on page 23. Following POR, the POR status bit in the Reset Status (RSTSTAT) Register is set to 1. Figure 6 displays Voltage Brown-Out operation. For the VBO and POR threshold voltages (V_{VBO} and V_{POR}), see the Electrical Characteristics chapter on page 196.

The VBO circuit can be either enabled or disabled during STOP Mode. Operation during STOP Mode is set by the VBO_AO Flash Option bit. For information about configuring VBO_AO, see the Flash Option Bits chapter on page 146.

For correct operation, the LED anode must be connected to V_{DD} and the cathode must be connected to the GPIO pin. Using all Port C pins in LED Drive Mode with maximum current can result in excessive total current. For the maximum total current for the applicable package, see the Electrical Characteristics chapter on page 196.

Shared Reset Pin

On the 8-pin product versions, the reset pin is shared with PA2, but the pin is not limited to output-only when in GPIO Mode.

Caution: If PA2 on the 8-pin product is reconfigured as an input, ensure that no external stimulus drives the pin Low during any reset sequence. Because PA2 returns to its RESET alternate function during system resets, driving it Low holds the chip in a reset state until the pin is released.

Shared Debug Pin

On the 8-pin version of this device only, the Debug pin shares function with the PA0 GPIO pin. This pin performs as a general purpose input pin on power-up, but the debug logic monitors this pin during the reset sequence to determine if the unlock sequence occurs. If the unlock sequence is present, the debug function is unlocked and the pin no longer functions as a GPIO pin. If it is not present, the debug feature is disabled until/unless another reset event occurs. For more details, see the On-Chip Debugger chapter on page 156.

Crystal Oscillator Override

For systems using a crystal oscillator, PA0 and PA1 are used to connect the crystal. When the crystal oscillator is enabled (see the Oscillator Control Register Definitions section on page 171), the GPIO settings are overridden and PA0 and PA1 are disabled.

5V Tolerance

All six I/O pins on the 8-pin devices are 5V-tolerant, unless the programmable pull-ups are enabled. If the pull-ups are enabled and inputs higher than V_{DD} are applied to these parts, excessive current flows through those pull-up devices and can damage the chip.

Note: In the 20- and 28-pin versions of this device, any pin which shares functionality with an ADC, crystal or comparator port is not 5V-tolerant, including PA[1:0], PB[5:0], and

Port A–C Data Direction Subregisters

The Port A–C Data Direction Subregister is accessed through the Port A–C Control Register by writing 01H to the Port A–C Address Register; see Table 22.

Table 22. Port A–C Data Direction Subregisters (PxDD)

Bit	7	6	5	4	3	2	1	0
Field	DD7	DD6	DD5	DD4	DD3	DD2	DD1	DD0
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 01H in Port A–C Address Register, accessible through the Port A–C Control Register.							

Bit	Description
[7:0] DDx	**Data Direction** These bits control the direction of the associated port pin. Port Alternate Function operation overrides the Data Direction register setting. 0 = Output. Data in the Port A–C Output Data Register is driven onto the port pin. 1 = Input. The port pin is sampled and the value written into the Port A–C Input Data Register. The output driver is tristated.

Note: x indicates the specific GPIO port pin number (7–0).

Port A–C Alternate Function Subregisters

The Port A–C Alternate Function Subregister (Table 23) is accessed through the Port A–C Control Register by writing 02H to the Port A–C Address Register. The Port A–C Alternate Function subregisters enable the alternate function selection on pins. If disabled, pins functions as GPIO. If enabled, select one of four alternate functions using alternate function set subregisters 1 and 2 as described in the the Port A–C Alternate Function Set 1 Subregisters section on page 48 and the Port A–C Alternate Function Set 2 Subregisters section on page 49. See the GPIO Alternate Functions section on page 34 to determine the alternate function associated with each port pin.

Caution: Do not enable alternate functions for GPIO port pins for which there is no associated alternate function. Failure to follow this guideline can result in unpredictable operation.

Port A–C Alternate Function Set 2 Subregisters

The Port A–C Alternate Function Set 2 Subregister (Table 29) is accessed through the Port A–C Control Register by writing 08H to the Port A–C Address Register. The Alternate Function Set 2 subregisters selects the alternate function available at a port pin. Alternate Functions selected by setting or clearing bits of this register is defined in Table 15 in the section the GPIO Alternate Functions section on page 34.

Table 29. Port A–C Alternate Function Set 2 Subregisters (PxAFS2)

Bit	7	6	5	4	3	2	1	0
Field	PAFS27	PAFS26	PAFS25	PAFS24	PAFS23	PAFS22	PAFS21	PAFS20
RESET	00H (all ports of 20/28 pin devices); 04H (Port A of 8-pin device)							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 08H in Port A–C Address Register, accessible through the Port A–C Control Register							

Bit	Description
[7:0] PAFS2x	**Port Alternate Function Set 2** 0 = Port Alternate Function selected as defined in Table 15 on page 33; also see the GPIO Alternate Functions section on page 34). 1 = Port Alternate Function selected as defined in Table 15.

Note: x indicates the specific GPIO port pin number (7–0).

Port A–C Input Data Registers

Reading from the Port A–C Input Data registers (Table 30) returns the sampled values from the corresponding port pins. The Port A–C Input Data registers are read-only. The value returned for any unused ports is 0. Unused ports include those missing on the 8- and 28-pin packages, as well as those missing on the ADC-enabled 28-pin packages.

Table 30. Port A–C Input Data Registers (PxIN)

Bit	7	6	5	4	3	2	1	0
Field	PIN7	PIN6	PIN5	PIN4	PIN3	PIN2	PIN1	PIN0
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	FD2H, FD6H, FDAH							

Bit	Description
[7:0] PxIN	**Port Input Data** Sampled data from the corresponding port pin input. 0 = Input data is logical 0 (Low). 1 = Input data is logical 1 (High).

Note: x indicates the specific GPIO port pin number (7–0).

LED Drive Level Low Register

The LED Drive Level registers contain two control bits for each Port C pin (Table 34). These two bits select between four programmable drive levels. Each pin is individually programmable.

Table 34. LED Drive Level Low Register (LEDLVLL)

Bit	7	6	5	4	3	2	1	0
Field	LEDLVLL[7:0]							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F84H							

Bit	Description
[7:0] LEDLVLL	**LED Level High Bit** {LEDLVLH, LEDLVLL} select one of four programmable current drive levels for each Port C pin. 00 = 3mA. 01 = 7mA. 10 = 13mA. 11 = 20mA.

Architecture

Figure 8 displays the interrupt controller block diagram.

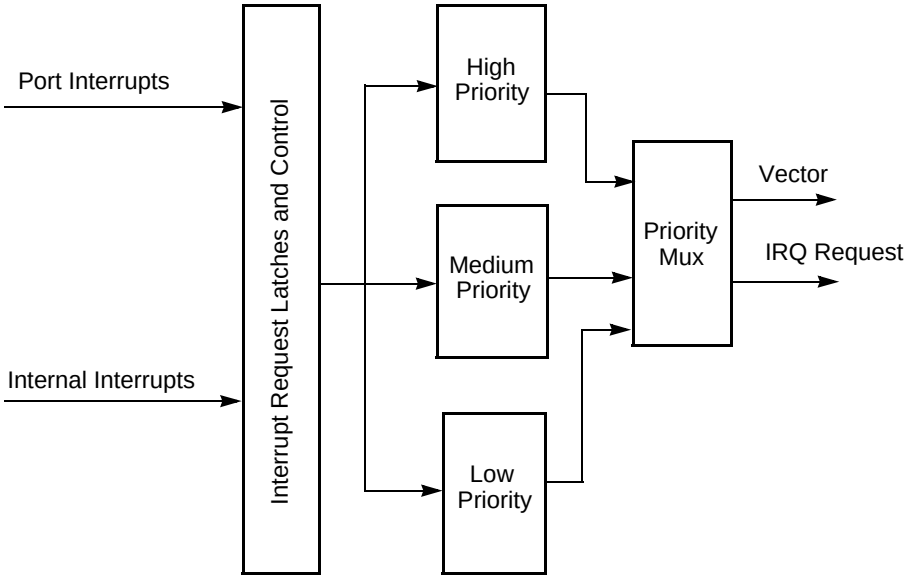

Figure 8. Interrupt Controller Block Diagram

Operation

This section describes the operational aspects of the following functions.

Master Interrupt Enable: see page 56

Interrupt Vectors and Priority: see page 57

Interrupt Assertion: see page 57

Software Interrupt Assertion: see page 58

Watchdog Timer Interrupt Assertion: see page 58

Master Interrupt Enable

The master interrupt enable bit (IRQE) in the Interrupt Control Register globally enables and disables interrupts.

Interrupts are globally enabled by any of the following actions:

- Execution of an Enable Interrupt (EI) instruction

Bit	Description (Continued)
[4] U0RXI	**UART 0 Receiver Interrupt Request** 0 = No interrupt request is pending for the UART 0 receiver. 1 = An interrupt request from the UART 0 receiver is awaiting service.
[3] U0TXI	**UART 0 Transmitter Interrupt Request** 0 = No interrupt request is pending for the UART 0 transmitter. 1 = An interrupt request from the UART 0 transmitter is awaiting service.
[2:1]	**Reserved** These bits are reserved and must be programmed to 00.
[0] ADCI	**ADC Interrupt Request** 0 = No interrupt request is pending for the ADC. 1 = An interrupt request from the ADC is awaiting service.

Interrupt Request 1 Register

The Interrupt Request 1 (IRQ1) register (Table 37) stores interrupt requests for both vectored and polled interrupts. When a request is presented to the interrupt controller, the corresponding bit in the IRQ1 Register becomes 1. If interrupts are globally enabled (vectored interrupts), the interrupt controller passes an interrupt request to the eZ8 CPU. If interrupts are globally disabled (polled interrupts), the eZ8 CPU reads the Interrupt Request 1 Register to determine if any interrupt requests are pending.

Table 37. Interrupt Request 1 Register (IRQ1)

Bit	7	6	5	4	3	2	1	0
Field	PA7VI	PA6CI	PA5I	PA4I	PA3I	PA2I	PA1I	PA0I
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC3H							

Bit	Description
[7] PA7VI	**Port A7 Interrupt Request** 0 = No interrupt request is pending for GPIO Port A. 1 = An interrupt request from GPIO Port A.
[6] PA6CI	**Port A6 or Comparator Interrupt Request** 0 = No interrupt request is pending for GPIO Port A or Comparator. 1 = An interrupt request from GPIO Port A or Comparator.
[5:0] PAxI	**Port A Pin *x* Interrupt Request** 0 = No interrupt request is pending for GPIO Port A pin *x*. 1 = An interrupt request from GPIO Port A pin *x* is awaiting service.

Note: x indicates the specific GPIO Port pin number (0–5).

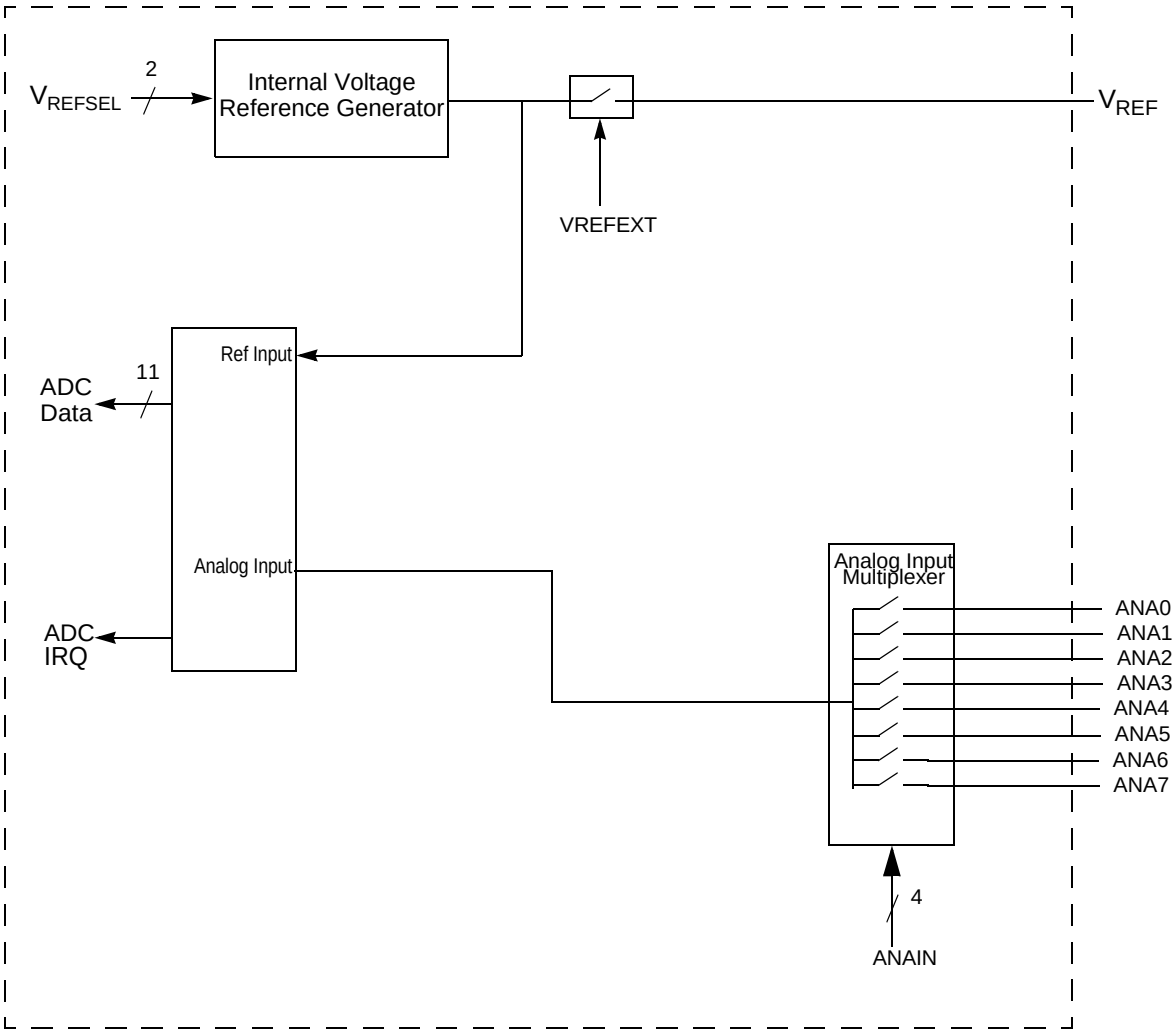

Figure 19. Analog-to-Digital Converter Block Diagram

Operation

The output of the ADC is an 11-bit, signed, two's-complement digital value. The output generally ranges from 0 to +1023, but offset errors can cause small negative values.

The ADC registers return 13 bits of data, but the two LSBs are intended for compensation use only. When the compensation routine is performed on the 13 bit raw ADC value, two bits of resolution are lost because of a rounding error. As a result, the final value is an 11-bit number.

ADC Data Low Bits Register

The ADC Data Low Byte register contains the lower bits of the ADC output as well as an overflow status bit. The output is a 11-bit two's complement value. During a single-shot conversion, this value is invalid. Access to the ADC Data Low Byte register is read-only. Reading the ADC Data High Byte register latches data in the ADC Low Bits Register.

Table 77. ADC Data Low Bits Register (ADCD_L)

Bit	7	6	5	4	3	2	1	0
Field	ADCDL			Reserved				OVF
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	F73H							

Bit	Description
[7:5] ADCDL	**ADC Data Low Bits** These bits are the least significant three bits of the 11-bits of the ADC output. These bits are undefined after a Reset.
[4:1]	**Reserved** These bits are reserved and are undefined when read.
[0] OVF	**Overflow Status** 0 = An overflow did not occur in the digital filter for the current sample. 1 = An overflow did occur in the digital filter for the current sample.

Comparator Control Register Definition

The Comparator Control Register (CMPCTL) configures the comparator inputs and sets the value of the internal voltage reference.

Table 78. Comparator Control Register (CMP0)

Bit	7	6	5	4	3	2	1	0
Field	INPSEL	INNSEL	REFLVL				Reserved	
RESET	0	0	0	1	0	1	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F90H							

Bit	Description
[7] INPSEL	**Signal Select for Positive Input** 0 = GPIO pin used as positive comparator input. 1 = temperature sensor used as positive comparator input.
[6] INNSEL	**Signal Select for Negative Input** 0 = internal reference disabled, GPIO pin used as negative comparator input. 1 = internal reference enabled as negative comparator input.
[5:2] REFLVL	**Internal Reference Voltage Level** 0000 = 0.0V. 0001 = 0.2V. 0010 = 0.4V. 0011 = 0.6V. 0100 = 0.8V. 0101 = 1.0V (Default). 0110 = 1.2V. 0111 = 1.4V. 1000 = 1.6V. 1001 = 1.8V. 1010–1111 = Reserved. **Note:** This reference is independent of the ADC voltage reference.
[1:0]	**Reserved** These bits are reserved; R/W bits must be programmed to 00 during writes and to 00 when read.

! **Caution:** Unintentional accesses to the Oscillator Control Register can actually stop the chip by switching to a non-functioning oscillator. To prevent this condition, the oscillator control block employs a register unlocking/locking scheme.

OSC Control Register Unlocking/Locking

To write to the Oscillator Control Register, unlock it by making two writes to the OSCCTL Register with the values E7H followed by 18H. A third write to the OSCCTL Register changes the value of the actual register and returns the register to a locked state. Any other sequence of Oscillator Control Register writes has no effect. The values written to unlock the register must be ordered correctly, but are not necessarily consecutive. It is possible to write to or read from other registers within the unlocking/locking operation.

When selecting a new clock source, the primary oscillator failure detection circuitry and the Watchdog Timer oscillator failure circuitry must be disabled. If POFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The Failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the Oscillator Control Register.

The internal precision oscillator is enabled by default. If the user code changes to a different oscillator, it is appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Should an oscillator or timer fail, there are methods of recovery, as this section describes.

Primary Oscillator Failure

Z8 Encore! XP F0823 Series devices can generate non-maskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer oscillator to drive the system clock. The Watchdog Timer oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is the primary oscillator. It is also unavailable if the Watchdog Timer oscillator is disabled, though it is not necessary to enable the Watchdog Timer reset function outlined in the the Watchdog Timer section on page 91.

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1kHz ±50%. If an external signal is selected as the system oscillator, it is possible that a very slow but non-failing clock can generate a failure condition. Under these

Table 110. Arithmetic Instructions (Continued)

Mnemonic	Operands	Instruction
MULT	dst	Multiply
SBC	dst, src	Subtract with Carry
SBCX	dst, src	Subtract with Carry using Extended Addressing
SUB	dst, src	Subtract
SUBX	dst, src	Subtract using Extended Addressing

Table 111. Bit Manipulation Instructions

Mnemonic	Operands	Instruction
BCLR	bit, dst	Bit Clear
BIT	p, bit, dst	Bit Set or Clear
BSET	bit, dst	Bit Set
BSWAP	dst	Bit Swap
CCF	—	Complement Carry Flag
RCF	—	Reset Carry Flag
SCF	—	Set Carry Flag
TCM	dst, src	Test Complement Under Mask
TCMX	dst, src	Test Complement Under Mask using Extended Addressing
TM	dst, src	Test Under Mask
TMX	dst, src	Test Under Mask using Extended Addressing

Table 112. Block Transfer Instructions

Mnemonic	Operands	Instruction
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses

Table 118. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
ADD dst, src	dst ← dst + src	r	r	02	*	*	*	*	0	*	2	3
		r	Ir	03							2	4
		R	R	04							3	3
		R	IR	05							3	4
		R	IM	06							3	3
		IR	IM	07							3	4
ADDX dst, src	dst ← dst + src	ER	ER	08	*	*	*	*	0	*	4	3
		ER	IM	09							4	3
AND dst, src	dst ← dst AND src	r	r	52	–	*	*	0	–	–	2	3
		r	Ir	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	dst ← dst AND src	ER	ER	58	–	*	*	0	–	–	4	3
		ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	–	–	–	–	–	–	1	2
BCLR bit, dst	dst[bit] ← 0	r		E2	–	–	–	–	–	–	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	–	–	–	0	–	–	2	2
BRK	Debugger Break			00	–	–	–	–	–	–	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	–	–	–	0	–	–	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	X	*	*	0	–	–	2	2
BTJ p, bit, src, dst	if src[bit] = p PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4

Note: Flags Notation:
* = Value is a function of the result of the operation.
– = Unaffected.
X = Undefined.
0 = Reset to 0.
1 = Set to 1.

Table 118. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
BTJNZ bit, src, dst	if src[bit] = 1 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
BTJZ bit, src, dst	if src[bit] = 0 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
CALL dst	SP ← SP –2 @SP ← PC PC ← dst	IRR		D4	–	–	–	–	–	–	2	6
		DA		D6							3	3
CCF	C ← ~C			EF	*	–	–	–	–	–-	1	2
CLR dst	dst ← 00H	R		B0	–	–	–	–	–	–	2	2
		IR		B1							2	3
COM dst	dst ← ~dst	R		60	–	*	*	0	–	–	2	2
		IR		61							2	3
CP dst, src	dst - src	r	r	A2	*	*	*	*	–	–	2	3
		r	Ir	A3							2	4
		R	R	A4							3	3
		R	IR	A5							3	4
		R	IM	A6							3	3
		IR	IM	A7							3	4
CPC dst, src	dst - src - C	r	r	1F A2	*	*	*	*	–	–	3	3
		r	Ir	1F A3							3	4
		R	R	1F A4							4	3
		R	IR	1F A5							4	4
		R	IM	1F A6							4	3
		IR	IM	1F A7							4	4
CPCX dst, src	dst - src - C	ER	ER	1F A8	*	*	*	*	–	–	5	3
		ER	IM	1F A9							5	3
CPX dst, src	dst - src	ER	ER	A8	*	*	*	*	–	–	4	3
		ER	IM	A9							4	3

Note: Flags Notation:
* = Value is a function of the result of the operation.
– = Unaffected.
X = Undefined.
0 = Reset to 0.
1 = Set to 1.

General Purpose I/O Port Output Timing

Figure 30 and Table 131 provide timing information for GPIO Port pins.

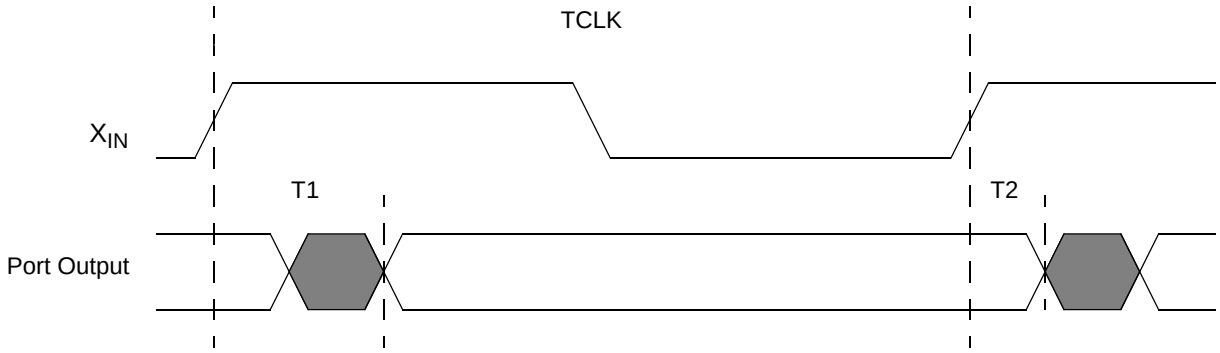

Figure 30. GPIO Port Output Timing

Table 131. GPIO Port Output Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
GPIO Port pins			
T_1	X_{IN} Rise to Port Output Valid Delay	–	15
T_2	X_{IN} Rise to Port Output Hold Time	2	–

On-Chip Debugger Timing

Figure 31 and Table 132 provide timing information for the DBG pin. The DBG pin timing specifications assume a 4 ns maximum rise and fall time.

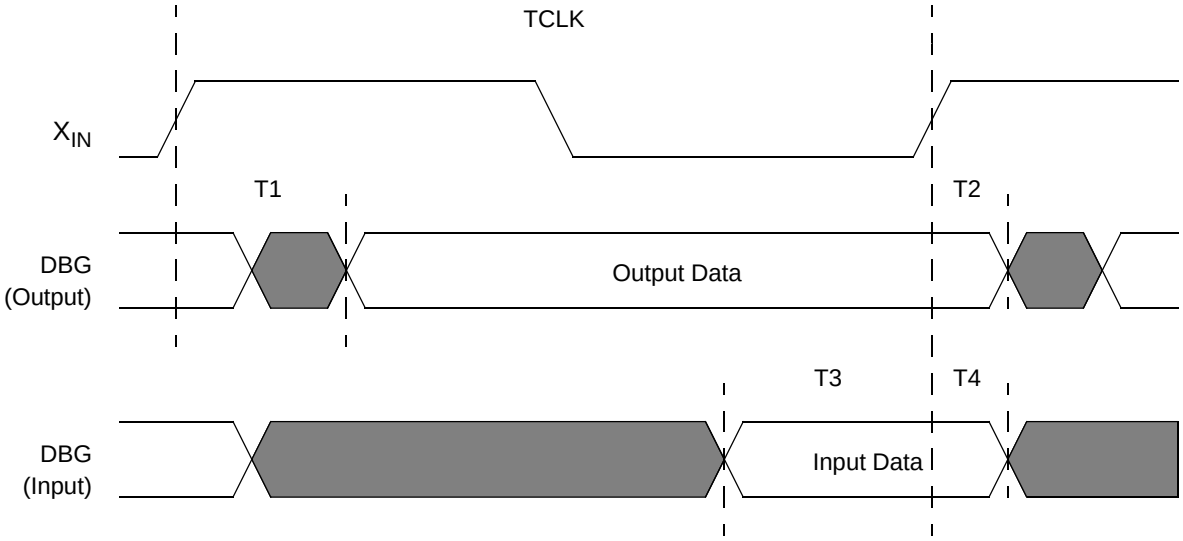

Figure 31. On-Chip Debugger Timing

Table 132. On-Chip Debugger Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
DBG			
T_1	X_{IN} Rise to DBG Valid Delay	–	15
T_2	X_{IN} Rise to DBG Output Hold Time	2	–
T_3	DBG to X_{IN} Rise Input Setup Time	5	–
T_4	DBG to X_{IN} Rise Input Hold Time	5	–

D

E

F